

Annex B2 - Product environmental attributes Servers/Data Storage Products

The declaration may be published only when all rows and/or fields marked with * are filled-in (N/A for not applicable). Additional information regarding each item may be found under P15.

Brand *	Lenovo	Logo			
Company name *	ny name * Lenovo				
Contact information *	Contact information * Lenovo Global Environmental Affairs		Lenovo		
e-mail address	nail address Alvin L Carter				
	alcarter@lenovo.com				
Internet site *	https://www.lenovo.com/us/en/about/sustainability				
Additional information	The latest version of this document can be found at:				
	http://www.lenovo.com/ecodeclaration				

The company declares (based on product specification or test results based obtained from sample testing), that the product				
conforms to the stateme	nts given in this declaration.			
Type of product *	SERVER			
Commercial name *	Lenovo ThinkSystem SR630			
Model number *	7X01, 7X02, 7Y93			
Issue date *	2020-01-31			
Intended market *	🔀 Global 📃 Europe 🗌 Asia, Pacific & Japan 🗌 Americas 🗌 Other			
Additional information				

This is an uncontrolled copy when in printed form. Please refer to the contact information for the latest version.

About Annex B2

Annex B2 reflects Product environmental attributes relevant for Computers and Computer Monitors. The following items from the ECMA-370 Main body are not shown in the template:

P4.1 – P4.3 Consumable materials

P9.1 TEC and Print speed

P10.2 - P10.3 Chemical emissions from printing products

P11.1 - P11.3 Consumable materials for printing products.

Model number *		7X01, 7X02, 7Y93	Logo			
Issue date *		2020-1-31		Leno		
Produc	t environ	mental attributes - Legal requirements		Require	men	t met
Item				Yes	No	N/A
P1		ous substances and preparations				
P1.1*	Products	do comply with current European RoHS Directive. (See legal reference and NOTE	E B1)	\square		
P1.2*		o do not contain Asbestos (see legal reference). nt: Legal reference has no maximum concentration value.		\square		
P1.3*	Products hydrobro trichloro	do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), profluorocarbons (HBFC), hydrochlorofluorcarbons (HCFC), Halons, carbontetrach ethane, methyl bromide (see legal reference). Comment: Legal reference has no m ration values.				
P1.4*		do not contain more than; 0,005% polychlorinated biphenyl (PCB), 0,005% polych I (PCT) in preparations (see legal reference).	lorinated	\boxtimes		
P1.5*	Products	do not contain more than 0,1% short chain chloroparaffins (SCCP) with 10-13 carl ntaining at least 48% per mass of chlorine in the SCCP (see legal reference).	bon atoms in	the 🔀		
P1.6*	(see leg	h direct and prolonged skin contact do not release nickel in concentrations above 0 al reference). nt: Max limit in legal reference when tested according to EN1811:2011-5.),5 μg/cm²/we	ek 🔀		
P1.7*	REACH Article 33 information about substances in articles is available at (add URL or mail contact): https://www.lenovo.com/us/en/sustainability-resources					
P2	Batterie	S				
P2.1*	If the product contains a battery or an accumulator, the battery/accumulator is labeled with the disposal symbol. Information on proper disposal is provided in user manual. (See legal reference)					
P2.2*	Batteries or accumulators do not contain more than 0,0005% of mercury or 0,002% of cadmium. (See legal					
P2.3*	Batteries	and accumulators are readily removable. (See legal reference)		\times		
P2.4*	Docume	ntation includes the number of cycles the (secondary) battery can withstand. (See I	egal referenc		Ħ	
P2.5*	When in	ternal batteries of a notebook computer cannot be "accessed and replaced by a note e related text is present and legible on the external packaging (see legal reference)	nprofessional	,		
P3		nity verification & Eco design (ErP)				
P3.1*	The proc	luct is CE-marked to show conformance with applicable legal requirements (see leg laration of Conformity can be requested at: https://www.lenovo.com/us/en/compliar				
P3.2*		luct complies with the Eco design requirements for energy-related products, al reference).		\boxtimes		
	Require	I information is; given in item P15 or added to this document, available at: https://www.lenovo.com/us/en/compliance/e	eco-declaratio			
P5	Product	packaging				
P5.1*	Packagi	ng and packaging components do not contain more than 0,01% lead, mercury ant chromium by weight of these together.	y, cadmium a	and 🔀		
P5.2*	The pac	kaging materials are marked with abbreviations and numbers indicating the nature of e legal reference).	of the materia	al(s) 🔀		
P5.3*	The proc (see leg	luct packaging material is free from ozone depleting substances as specified in the N al reference). ht: Legal reference has no maximum concentration values.	Montreal Proto	ocol 🔀		
P6	Treatme	nt information				
P6.1*	Informat	on for recyclers/treatment facilities is available (see legal reference).		\square		

NOTE B1 Restriction applies to the homogeneous material, unless other specified and expressed in weight %. Stating "Yes" means that the product is compliant with the mandatory requirements.

Model number * Issue date *		7X01, 7X02, 7Y93	Logo			
		2020-1-31		Len	ovc	DTH
Product	t environ	mental attributes - Market requirements (See General NOTE GN	below)			
		onmental conscious design		Require		
Item		tory to fill in. Additional information regarding each item may be found under P14.		Yes	No	N/A
P7.1*		Disassembly, recycling It have to be treated separately are easily separable				
P7.2*		naterials in covers/housing have no surface coating.			╞	╞
P7.3*	Plastic parts > 100 g consist of one material or of easily separable materials.					
P7.4*		arts > 25 g have material codes according to ISO 11469 referring ISO 1043-4.			╞	╞
P7.5	-	arts are free from metal inlays or have inlays that can be removed with commonly a	available tools		╞	╞
P7.6*		re easily separable. (This requirement does not apply to safety/regulatory labels).			╞	╞
17.0	Product					
P7.7*		ing can be done e.g. with processor, memory, cards or drives				
P7.8*		ing can be done using commonly available tools			⊢⊢	⊢⊢
P7.9		arts are available after end of production for: years				╞
P7.10		s available after end of production for: years				╞
17.10		and substance requirements				
P7.11*		cover/housing material type (e.g. plastics, metal, aluminum):				
		type: Steel Material type: PC+ABS Materia	al type:			
P7.12	Insulatio	n materials of external electrical cables are PVC free.			\square	
P7.13	Insulatio	n materials of internal electrical cables are PVC free.			\boxtimes	
P7.14	weight (´ polyvinyl	plastic casing/cover parts > 25 g contain no more than 0,1% weight (1000 ppm) b 1000 ppm) chlorine attributable to brominated flame retardants, chlorinated flame chloride or 0,3% weight (3000 ppm) bromine and 0,3% weight (3000 ppm) chlorine i in 25% post-consumer recycled content.	e retardants, ar	nd		
P7.15	Printed c	ircuit boards, PCBs (without components) are low halogen: all	are low haloge	en 🗌		
P7.16		tarded plastic parts > 25 g in covers / housings are marked according ISO 1043-4:				
P7.17		nemical specifications of flame retardants in printed circuit boards > 25 g (without co additive) , TBBPA (reactive) (See NOTE B3), Other: chemical name:	omponents): , CAS #:			
		nemical specifications of flame retardants in printed circuit boards (without compone g ISO 1043-4:	ents) > 25 g			
P7.18	concentr 1. Chemi 2. Chemi	ame retarded plastic parts > 25 g contain the following flame retardant substance ations above 0,1%: ical name: , CAS #: (See NOTE B4) ical name: , CAS #: " ical name: , CAS #: "	es/preparations	in		
		nemical specifications of flame retardants in plastic parts > 25 g according ISO 104				
P7.19	assigned	parts > 25 g, flame retardant substances/preparations above 0,1% are used which the following Risk phrases; and Hazard statements:				
P7.20*		rce(s) for these classifications is/are found at (add URL(s)): , (S sumer recycled plastic material content is used in the product (See Note B6):	See note B5)			
	a) Oft ape or	It least one of the two alternatives below shall be answered; otal plastic parts' weight > 25 g, the postconsumer recycled plastic material conten ercentage of total plastic by weight) is %. e weight of recycled material is g.	t (calculated as			

GENERAL NOTE Standard references should direct to the latest version of a standard. If an older version of a standard is used, section P15 shall be used for explanation.

NOTE B2 IEC 61249-2-21 defines maximum limits of 900 ppm for each of the substances chlorine and bromine and a maximum limit of 1500ppm of these substances combined. The standard does not address fluorine, iodine and astatine which are included in the group of halogens.

NOTE B3 and B4 A Guidance document on Chemical substances is available; see <u>http://www.ecma-international.org/publications/standards/Ecma-370.htm</u>.

NOTE B5 If a certain substance has been assigned a certain risk phrases / hazard statement in the referenced source, this does not necessarily mean the substance has been tested for all of the hazards referred to by a certain customer.

NOTE B6 Applies to a product containing plastic parts whose combined weight exceeds 100 g with the exception of printed circuit boards, cables, connectors and electronic components and bio-based plastic material.

Model number *	7X01, 7X02, 7Y93	Logo	Lenovo			
Issue date *	2020-1-31		LEHOVO			
Product environmental attributes - Market requirements (continued) Requirement met						

Requirement metYesNoN/A

	Material and substance requirements (continued)							
P7.21*		material content is used		DTE B7):				
	If YES; at least one of the two alternatives below shall be answered; a) Of total plastic parts' weight > 25 g, the biobased plastic material content (calculated as a percentage of total plastic by weight) is %. or							
		of the biobased plastic n	naterial is g.					
P7.22*	Light sources are free from mercury, i.e. less than 0,1 mg/lamp.							
P7.23*	If product includes an integral display, the total mercury content in the integrated display: mg							
P8	Batteries							
P8.1*	Battery chemical	composition:						
P9	Energy consum	ption (See NOTE B8)						
P9.1	For the product t	he following power levels	s or energy consumptio	ns are reported:				
Energy mo	de *	Power level at 100 V AC	Power level at 115 V AC	Power level at 230 V AC	Reference/Standard for energy X modes and test method *			
Peak (On-I	max)	W	W	W	Full load			
Categor	V							
EPS No-loa		W	W	W				
	ower supply /	**	••					
· ·	igged in the wall							
	isconnected from							
the product	i.)							
PTEC *	and Consumption	W	W	W				
ETEC *	ergy Consumption	kWh/year	kWh/year	kWh/year				
	ergy Consumption		Kvvii/yeai	Kvvii/year				
	0, .	ency Level (International	Efficiency Marking Prof	tocol) * :				
Display res	olution * : I	negapixels						
Default time	e to enter energy	save mode: minut	es					
P9.2*	Information about	t the energy save function	on is provided with the p	product.				
P9.3	Energy efficiency	/ class (monitors only):	· · · · · · · · · · · · · · · · · · ·					
P10	Emissions Noise emission	- Declared according to	ISO 9296 (See NOTF	B9)				
P10.1	Mode	Mode description			it A-weighted sound power level, <i>L_{WA,c}</i> (B)			
-	Idle	* HDD idle		* 5.8				
	Operation	* HDD Operating		* 6.0				
	Other mode	Declared A-weighted sound		43 (operator positio	on desktop – idle)			
	Other mode Declared A-weighted sound pressure level (dB) L _{pAm}			49 (operator positio	on desktop – operating)			
	Measured according to: X ISO 7779 ECMA-74							
	Electromagneti	Other	(only if not covered by					
P10.4		y meets the requirement	for low frequency elect	romagnetic fields of th	ne following voluntary			
	program(s):							

Item

NOTE B7 The following is to be excluded from the calculation of percentage: printed circuit boards, labels, cables, connectors and electronic components and postconsumer recycled plastic

NOTE B8 A Guidance document on Energy Efficiency is available;

see http://www.ecma-international.org/publications/standards/Ecma-370.htm

NOTE B9 A Guidance document on Acoustic Noise is available; see <u>http://www.ecma-international.org/publications/standards/Ecma-370.htm</u>

Model nu	ımber *	7X01, 7X02, 71	/93			Logo				
Issue date *		2020-1-31						eno	VO	DH .
Product	environn	nental attribut	tes - Market require	ments (continu	ied)			Require	ment	met
Item			- -					Yes	No	N/A
P12		nics for compu								
P12.1*	The disp	lay meets the er	gonomic requirements	of ISO 9241-307	or visual displa	ay technologies.				\boxtimes
P12.2*	The phys	sical input device	e meets the requiremen	its of ISO 9995 ar	d ISO 9241-41	0.				\boxtimes
P13	Packagi	ng and docume	entation							
P13.1*	Product	00	ial type(s): <i>LDPE</i> ial type(s): <i>EPE</i> ial type(s):	weight (kg): <i>0.</i> weight (kg): <i>0.</i> weight (kg):						
P13.2*			ackaging is free from P	VC.				\square		
P13.3*		luct primary cor	rugated fiberboard pac r content: 55 %	ckaging, specify t	ne contained p	percentage of mir	nimum pos			
P13.4*		nedia for user al onic, XPaper,	nd product documentati	ion (tick box):						
P13.5	(Please only complete this item if paper documentation used) User and product documentation on paper media is chlorine-free:									
		hlorine-free al chlorine-free								
	Processe	ed chlorine-free						H		
P14	Volunta	ry programs								
P14.1			equirements of the follow	wing voluntary pro	gram(s):					
	ENERG) Eco-labe Eco-labe		Criteria version: Criteria version: Criteria version:	Da Da Da	e:	Product categor Product categor Product categor	y:			
P15			(See NOTE B10)							
P9 P9	NOTE: S the infor supplier informat Account	Supplier makes rmation contair 's knowledge a tion. The inforn t Representativ	f computer products; no representations, g ed in this document. vailable at the time of nation provided here is e for more information ied Enterprise Servers	uarantees, assu All information µ f completion, and s approximate a n.	rances or warn rovided by su I supplier shal nd provided fo	ranties whether e pplier in this doc Il have no obligat	express or cument is p tion to upo	provided late such	based	lon
1 J			<u>.gov/products/data_c</u>			<u>ervers</u>				

NOTE B10 Additional lines may be inserted to declare further items, by positioning the cursor at the far right of the row and hitting the <Enter> key.

Legal references Europe Annex B2

Reference	Declaration item
Directive 2011/65/EU (RoHS Directive)* * Specific exemptions apply for certain products and applications.	P1.1, P3.1
Regulation (EC) 1907/2006 (REACH Regulation), annex XVII	P1.2, P1.4, P1.6, P1.7
Regulation (EC) 2037/2000, 2038/2000, 2039/2000 (Marketing and use of Ozone layer depleting substances)	P1.3, P5.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
Directive 2006/66/EC (Battery and accumulators Directive), as amended.* * These provisions shall not apply where, for safety, performance, medical or data integrity reasons, continuity of power supply is necessary and requires a permanent connection between the appliance and the battery or accumulator.	P2.1, P2.2, P2,3, P8.1
Directive 2014/35/EU (Low Voltage Directive)	P3.1
Directive 2014/30/EU (EMC Directive)	P3.1
Directive 2014/53/EU (RE Directive)	P3.1
Regulation (EC) 801/2013 amending Regulation (EC) No 1275/2008 with regard to ecodesign requirements for standby, off mode electric power consumption of electrical and electronic household and office equipment, and amending Regulation (EC) No 642/2009 with regard to ecodesign requirements for televisions	P3.1, P3.2
Commission Regulation (EC) No 278/2009 of 6 April 2009 implementing Directive 2005/32/EC of the European Parliament and of the Council with regard to ecodesign requirements for no-load condition electric power demand and average active efficiency of external power supplies	P3.1, P3.2, P9.1
COMMISSION REGULATION (EU) No 617/2013 of 26 June 2013 implementing Directive 2009/125/EC of the European Parliament and of the Council with regard to ecodesign requirements for computers and computer servers	P2.4, P2.5, P3.1, P3.2, P7.23, P9.1
Regulation (EC) No 1272/2008 (CLP Regulation)	P7.19
Directive 2004/12/EC (Packaging Directive)	P5.1
Decision 97/129/EC (Secondary packaging legislation)	P5.2
Directive 2012/19/EU (WEEE directive)	P6.1
Implementing Regulation (EU) 2019/290 establishing the format for registration and reporting of producers of electrical and electronic equipment to the register.	
Commission Implementing Regulation 2017/699 establishing a common methodology for the calculation of the weight of electrical and electronic equipment (EEE) placed on the national market in each Member State and a common methodology for the calculation of the quantity of waste electrical and electronic equipment (WEEE) generated by weight in each Member State.	

Lenovo ErP Lot9 Information Sheet - Servers & Storage Products-

As required by COMMISSION REGULATION (EU) 2019/424 of 15 March 2019 laying down ecodesign requirements for servers and data storage products pursuant to Directive 2009/125/EC of the European Parliament and of the Council and amending Commission Regulation (EU) No 617/2013. (ErP Lot9)

Products scope of this sheet: Servers & storage products

This document is only valid in connection with the IT Eco Declaration of the specific Product.

SERVERS

General information

Commercial name (3.1 (b))	Lenovo ThinkSystem SR630	Logo	
Contact Address (3.1 (b))	7001 Development Dr. Building 7,Morrisville, NC 27560, United		
	States		
Model Number (3.1 (c))	7X01, 7X02, 7Y93		Lenovo.
Issue Date	2020-01-31		
Additional information			

Product environmental attributes (EU) 2019/424 – Annex II points 3.1 and 3.3						
1.a	Is the product consider to be in scope of ErP Lot 9 🛛 🔀 in scope 🗌 out of scope, product is out of scope as:					
1.b	Server type 🛛 🔀 Rack Server 📃 High Performance Computing (HPC)					
(3.1 (a))						
	Blade Server Data Storage product (Please go to "DATA STORAGE PRODUCTS" section					
1.c (3.1 (d))	Year of manufacture: 2020					
1.d	Product model part of a server product family? 🛛 🗌 No 🔀 Yes					
(3.1 (p))	List of all model configurations that are represented by the model: http://psref.lenovo.com/Product/ThinkSystem/ThinkSystem_SR630					
1.e	Information on the secure data deletion functionality					
(3.1 (n))	(a) instructions on how to use the functionality:					
	2 methods are provided to use the functionality.					
	1) Use a command line tool to do the secure data deletion on the remote target system via boot up a customized					
	Linux OS on it. Eg: OneCli.exe serase –bmc USERID:PASSWORD@xx.xx.xx.xxsftp root:password@xx.xxx.xx.xx:/home –log 5					
	2) Use BoMC to create a full functions bootable media, start the media and choose secure erase from the text menu.					
	(b) techniques used:					
	OS tools under Linux -> Standard Linux Open Source tool (c) supported secure data deletion standard (if any):					
	Secure Erase/block Erase/Crypto Erase, Sanitize					
	OR - Reference to other information:					
	Hdparm: <u>https://en.wikipedia.org/wiki/Hdparm</u>					
	Nvme-format: https://www.mankier.com/1/nvme-format					
	sg_sanitize: https://www.systutorials.com/docs/linux/man/8-sg_sanitize/					
	scrub: https://www.systutorials.com/docs/linux/man/1-scrub/					
	storcli: https://docs.broadcom.com/docs-and-downloads/raid-controllers/raid-controllers-common-iles/StorCLI_RefMan_revf.pdf					
1.f (3.1 (o))	Blade servers? 🛛 No 🗌 Yes					
,	list of recommended combinations with compatible chassis:					
Recycling 2.a	Indicative weight range at component level, of the (a) Cobalt in the batteries (b) Neodymium in the HDDs					
(3.3 (a))	following critical raw materials: \square less than 5 g \square less than 5 g					
	between 5 g and 25 g					
	above 25 g Above 25 g					
2.b	Instructions on the disassembly operations					
(3.3 (b))	 (a) the type of operation; (b) the type and number of factoring technique(c) to be unleaked; 					
	 (b) the type and number of fastening technique(s) to be unlocked; (c) the tool(s) required. 					
2.0	OR - Reference to other information: https://thinksystem.lenovofiles.com/help/index.jsp Firmware					
2.c	Reference to information on last available firmware:					
	https://datacentersupport.lenovo.com/cn/en/products/servers/thinksystem/sr630/downloads/driver-list/					
Additional	l information					

Server family specific information Family 1

Family	no. / name	1 - 1 CPU populate	ed family				
	number(s) / Description	Standard or low-end p	erformance configuration:				
(3.1 (c))		Processor(Minimum result of core count * frequency in family): Intel Xeon Silver 4112, Storage: 1TB					
		HDD * 2, Memory: 16GB(lowest capacity in family) * 6, PSU: 550W * 1, NIC: 4port 1G RJ45					
		High-end performance configuration:					
		Processor(Maximum r	result of core count * frequency in f	family): Intel Xeon Gold 8280, Storage:			
		480GB SSD * 2, Memo	ry: 32GB * 12, PSU: 750W * 2, NIC:	4port 1G RJ45			
		You can refer to https://	//www.plugloadsolutions.com/80Plu	usPowerSuppliesDetail.aspx?id=49&type=1			
Additional information along with <u>http://psref.lenovo.com/Product/ThinkSystem/ThinkSystem_SR630</u> for the PSU efficiency details.							
			Annex II points 3.1 and 3.3				
F1.a	PSU efficiency at 10	% (if applicable), 20 %, 5	50 % and 100 % of rated output power	r			
(3.1 (e))	(expressed in % and	rounded to the first decir	nal place): 🗌 Multi-output 🛛 🔀 Sing	ale-output			
			. ,				
	Standard or low-end	performance configuration	on(s):				
			100% 93.99% Average 94.30%				
			-				
	High-end performance	ce configuration(s):					
			100% 93.33% Average 93.79%				
F1.b		of the rated load level	standard or low-end performa				
(3.1 (f))	(rounded to three de	1 /	configuration: 0.990	configuration: 1.000			
F1.c	PSU rated power out		standard or low-end performa				
(3.1 (g))	(in Watts rounded to	the nearest integer)	configuration: 550	configuration: 750			
	internal note:						
	If a product model is part of a ser	ver product family, all PSUs offered in a vith the information specified in (e) and (server fi				
F1.d	idle state power	win the mornauon specified in (e) and (standard or low-end performa	ance high-end performance			
(3.1 (h))		ed to the first decimal place		configuration: 101.8			
F1.e		ts for additional idle powe					
(3.1 (i))							
(- ())		stan	dard or low-end performance	high-end performance			
			iguration:	configuration:			
	CPU Performance		1 Socket (10 × PerfCPU W)	X 1 Socket			
S			2 Socket (7 × PerfCPU W)	2 Socket			
ent	Additional PSU	,	Yes / No) #: 0	Yes(Yes / No) #: 1 No(Yes / No) #: 0			
stm	HDD		(Yes / No) #: 2				
allowances adjustments during testing	SDD		(es / No) #: 0	Yes(Yes / No) #: 2			
s ac	Additional memory		(Yes / No) #: 92GB	Yes(Yes / No) #: 380GB			
ces	Additional buffered DDF	R channel No(Yes / No) #: 0	No (Yes / No) #: 0			
van ig ti	Additional I/O devices		none	none			
lri lov			< 1 Gb/s: No Allowance	< 1 Gb/s: No Allowance			
power			= 1 Gb/s: 2,0 W/Active Port	= 1 Gb/s: 2,0 W/Active Port			
bd		· [_] ;	> 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port	> 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port			
idle		· · · · · · · · · · · · · · · · · · ·	≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port	≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port			
			≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port	≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port			
		一,	≥ 50 Gb/s 26,0 W/Active Port	≥ 50 Gb/s 26,0 W/Active Port			
F1.f	maximum powor		standard or low-end performa				
Г Г.I (3.1 (j))	maximum power	ed to the first decimal plac	•	configuration: 399.1			
F1.g			standard or low-end performation				
F1.g (3.1 (k))	operating condition of						
(0.1 (K))	(as defined in Table	6 01 ETP 101 9)	configuration:	configuration:			
			A1 🛛 A2 🗌 A3 🗌 A4	A1 🛛 A2 🗌 A3 🗌 A4			
			Exception comments	Exception comments			
F1.h							
	idle state power at the higher boundary temperature standard or low-end performance high-end performance of the declared operating condition class (in Watts) configuration: 100.9 configuration: 130						
(3.1 (l))							
(3.1 (I)) F1.i		ency and the performanc		ance high-end performance configuration: 31.7			

Server family specific information Family 2

Family r	amily no. / name 2 - 2 CPUs populated family						
-	umber(s) / Description	Ctondord or low		my anas configuration:			
(3.1 (c))	unber(s) / Description			l performance configuration: result of core count * frequency in family): Intel Xeon Bronze 4112, Storage:			
(0.1 (0))				(lowest capacity in family) * 1			
		High-end perform			2, 1 30. 3000		
					amily): Intel Xeon Gold 8280 * 2, Storage:		
	480GB SSD * 2, Memory: 32GB * 24, PSU: 750W * 2						
					PowerSuppliesDetail.aspx?id=49&type=1		
Addition	nal information				System SR630 for the PSU efficiency		
		details.					
Produc	t environmental attri	butes (FU) 2019/4	24 – Annex I	points 3.1 and 3.3			
F2.a	See family 1						
(3.1 (e))	Or specific to this far	ail					
,	•		0% 50% an	d 100 % of rated output power			
				ce) : Multi-output Singl	e-output		
	standard or low-end 10% 20%	50%	100%	Average			
	10 /8 20 /8	50 %	100 %	Average			
	high-end performanc	e configuration(s).					
	10% 20%	50%	100%	Average			
F2.b	Power factor at 50 %			See family 1			
(3.1 (f))	(rounded to three de			Or specific to this family:			
,,	(ennar placee,		standard or low-end performar	nce high-end performance		
				configuration:	configuration:		
F2.c	PSU rated power out	tout			comgaration.		
(3.1 (g))	(in Watts rounded to)	See family 1			
(* (5/)		the nearest integer	/	Or specific to this family:			
	internal note:			standard or low-end performar	nce high-end performance		
	If a product model is part of a ser product family shall be reported v	ver product family, all PSUs of	fered in a server	configuration:	configuration:		
F2.d	idle state power	with the information specified in	(e) and (i)	standard or low-end performar			
(3.1 (h))	(in Watts and rounde	d to the first decim	al nlaca)	configuration: 109.9	configuration: 148.9		
F2.e	List of all component						
(3.1 (i))	List of all component			low-end performance	high-end performance		
(0.1 (.))			configuratio	-	configuration:		
	CPU Performance				1 Socket		
	or or chomanee			et (10 × PerfCPU W)			
s				et (7 × PerfCPU W)	🔀 2 Socket		
idle power allowances adjustments during testing	Additional PSU		No(Yes / No)		Yes (Yes / No) #: 1		
stm	HDD		Yes(Yes / No)		No(Yes / No) #: 0		
dju	SDD		No(Yes / No)		Yes(Yes / No) #: 2		
s a ing	Additional memory		Yes(Yes / No)		Yes(Yes / No) #: 764		
icet	Additional buffered DDF	R channel	Yes(Yes / No)) #: 4	Yes(Yes / No) #: 4		
ng t	Additional I/O devices		none		none		
allo			< 1 Gb/s: I	No Allowance	< 1 Gb/s: No Allowance		
era			= 1 Gb/s: 2	2,0 W/Active Port	= 1 Gb/s: 2,0 W/Active Port		
NO				nd < 10 Gb/s: 4,0 W/Active Port	> 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port		
e D					\geq 10 Gb/s and < 25Gb/s: 15,0 W/Active Port		
<u>id</u>				and < 25Gb/s: 15,0 W/Active Port			
			≥ 25 Gb/s	and < 50Gb/s: 20,0 W/Active Port	≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port		
			≥ 50 Gb/s	26,0 W/Active Port	≥ 50 Gb/s 26,0 W/Active Port		
F2.f	Maximum power			standard or low-end performar			
(3.1 (j))	(in Watts and rounde		al place)	configuration: 218.2	configuration: 735.9		
(3.1 (k))	Operating condition of			🔀 See family 1			
	(as defined in Table	6 or ErP lot 9)		Or specific to this family:			
				standard or low-end performar			
				configuration:	configuration:		
				A1	A1		
				A2	A2		
		A3	A3				
				A4	A4		
				Exception comments	Exception comments		
				Exception comments			
F2.h	idle state power at th	e higher boundary	temperature	See family 1			
(3.1 (l))	of the declared opera			Or specific to this family:			
	(in Watts)	<u>.</u>		standard or low-end performar	nce high-end performance		
	(configuration: 129.9	configuration: 167		
F2.i	the active state effici	ency and the perfor	mance in				
(3.1 (m))	active state of the se			See family 1			
//				Or specific to this family: standard or low-end performant	nce high-end performance		
				configuration: 16.3	configuration: 36		